

## Applications

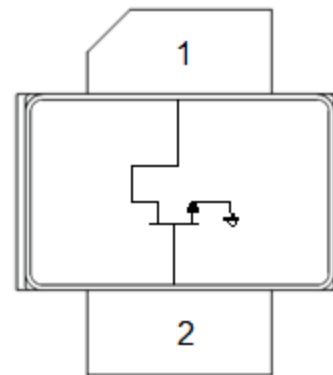
- Military radar
- Civilian radar
- Professional and military radio communications
- Test instrumentation
- Wideband or narrowband amplifiers
- Jammers



## Product Features

- Frequency: DC to 3.5 GHz
- Output Power ( $P_{3dB}$ ): 45 W at 3.3 GHz
- Linear Gain: >19 dB at 3.3 GHz
- Operating Voltage: 32 V
- Low thermal resistance package

## Functional Block Diagram



## General Description

The TriQuint T1G4004532-FS is a 45W ( $P_{3dB}$ ) discrete GaN on SiC HEMT which operates from DC to 3.5 GHz. The device is constructed with TriQuint's proven TQGaN25 process, which features advanced field plate techniques to optimize power and efficiency at high drain bias operating conditions. This optimization can potentially lower system costs in terms of fewer amplifier line-ups and lower thermal management costs.

Lead-free and ROHS compliant

Evaluation boards are available upon request.

## Pin Configuration

Pin No.	Label
1	$V_D$ / RF OUT
2	$V_G$ / RF IN
Flange	Source

## Ordering Information

Part	ECCN	Description
T1G4004532-FS	EAR99	Packaged part Flangeless
T1G4004532-FS-EVB1	EAR99	2.7-3.5 GHz Evaluation Board

## Absolute Maximum Ratings

Parameter	Value
Breakdown Voltage ( $V_{DG}$ )	100 V min.
Gate Voltage Range ( $V_G$ )	-7 to 0 V
Drain Current ( $I_D$ )	7.0 A
Gate Current ( $I_G$ )	-12.6 to 21 mA
Power Dissipation, CW ( $P_D$ )	61 W
RF Input Power, CW, T = 25 °C ( $P_{IN}$ )	41 dBm
Channel Temperature ( $T_{CH}$ )	275 °C
Mounting Temperature (30 Seconds)	320 °C
Storage Temperature	-40 to 150 °C

Operation of this device outside the parameter ranges given above may cause permanent damage. These are stress ratings only, and functional operation of the device at these conditions is not implied.

## Recommended Operating Conditions

Parameter	Value
Drain Voltage ( $V_D$ )	32 V (Typ.)
Drain Quiescent Current ( $I_{DQ}$ )	220 mA (Typ.)
Peak Drain Current ( $I_D$ )	2.5 A (Typ.)
Gate Voltage ( $V_G$ )	-2.9 V (Typ.)
Channel Temperature ( $T_{CH}$ )	225 °C (Max.)
Power Dissipation, CW ( $P_D$ )	44 W (Max)
Power Dissipation, Pulse ( $P_D$ )	68 W (Max)

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

Operating conditions are based on 100 usec, 20% unless otherwise specified.

## RF Characterization – Load Pull Performance at 1.0 GHz <sup>(1)</sup>

Test conditions unless otherwise noted:  $T_A = 25$  °C,  $V_D = 32$  V,  $I_{DQ} = 220$  mA

Symbol	Parameter	Min	Typical	Max	Units
$G_{LIN}$	Linear Gain		23.4		dB
$P_{3dB}$	Output Power at 3 dB Gain Compression		40.1		W
$DE_{3dB}$	Drain Efficiency at 3 dB Gain Compression		57.2		%
$PAE_{3dB}$	Power-Added Efficiency at 3 dB Gain		56.7		%
$G_{3dB}$	Gain at 3 dB Compression		20.4		dB

Notes:

- $V_{DS} = 32$  V,  $I_{DQ} = 220$  mA; Pulse: 100 $\mu$ s, 20%

## RF Characterization – Load Pull Performance at 3.5 GHz <sup>(1)</sup>

Test conditions unless otherwise noted:  $T_A = 25$  °C,  $V_D = 32$  V,  $I_{DQ} = 220$  mA

Symbol	Parameter	Min	Typical	Max	Units
$G_{LIN}$	Linear Gain		20.0		dB
$P_{3dB}$	Output Power at 3 dB Gain Compression		45.0		W
$DE_{3dB}$	Drain Efficiency at 3 dB Gain Compression		56.8		%
$PAE_{3dB}$	Power-Added Efficiency at 3 dB Gain		55.7		%
$G_{3dB}$	Gain at 3 dB Compression		17.0		dB

Notes:

- $V_{DS} = 32$  V,  $I_{DQ} = 220$  mA; Pulse: 100 $\mu$ s, 20%

## RF Characterization – Performance at 3.3 GHz <sup>(1, 2)</sup>

Test conditions unless otherwise noted:  $T_A = 25\text{ }^\circ\text{C}$ ,  $V_D = 32\text{ V}$ ,  $I_{DQ} = 220\text{ mA}$

Symbol	Parameter	Min	Typical	Max	Units
$G_{LIN}$	Linear Gain		19.5		dB
$P_{3dB}$	Output Power at 3 dB Gain Compression		44.0		W
$DE_{3dB}$	Drain Efficiency at 3 dB Gain Compression		52.0		%
$G_{3dB}$	Gain at 3 dB Compression		16.5		dB

Notes:

1. Performance at 3.3 GHz in the 2.7 to 3.5 GHz Evaluation Board
2.  $V_{DS} = 32\text{ V}$ ,  $I_{DQ} = 220\text{ mA}$ ; Pulse: 100 $\mu\text{s}$ , 20%

## RF Characterization – Narrow Band Performance at 3.50 GHz <sup>(1)</sup>

Test conditions unless otherwise noted:  $T_A = 25\text{ }^\circ\text{C}$ ,  $V_D = 32\text{ V}$ ,  $I_{DQ} = 220\text{ mA}$

Symbol	Parameter	Typical
VSWR	Impedance Mismatch Ruggedness	10:1

Notes:

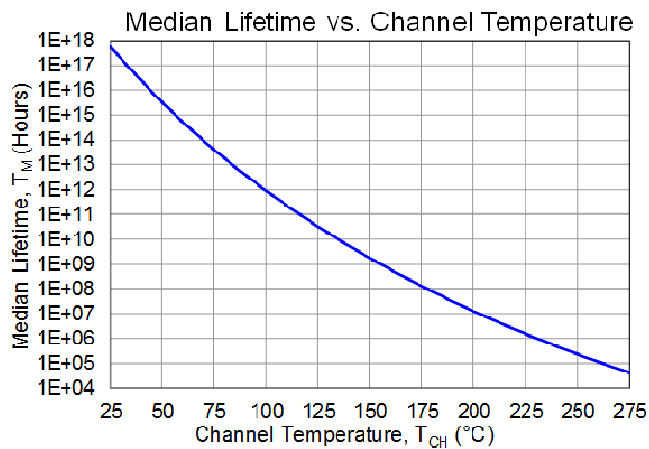
1.  $V_{DS} = 32\text{ V}$ ,  $I_{DQ} = 220\text{ mA}$ , CW at  $P_{3dB}$
2. Input power established at  $P_{3dB}$  under matched condition

## Thermal and Reliability Information

Parameter	Test Conditions	Value	Units
Thermal Resistance ( $\theta_{JC}$ )	DC at 85 °C Case	3.2	°C/W
Channel Temperature ( $T_{CH}$ )		225	°C

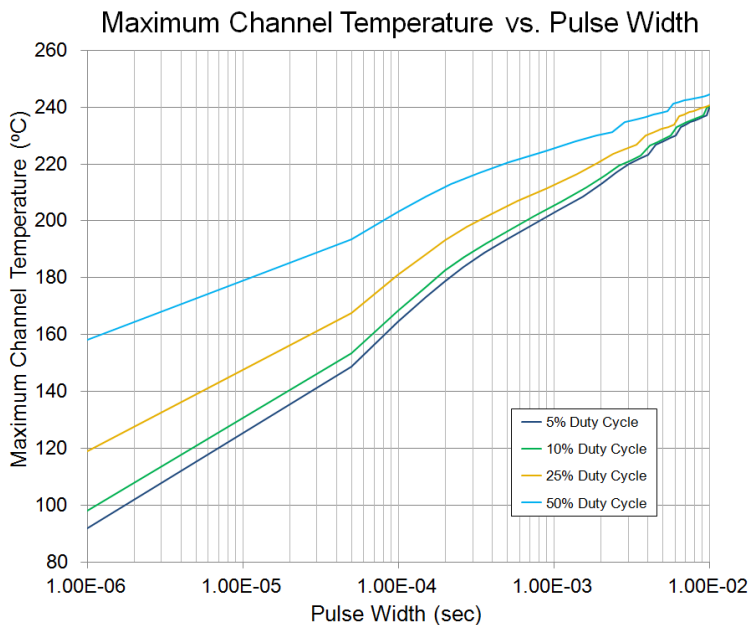
Notes:  
 Thermal resistance measured to bottom of package

## Median Lifetime



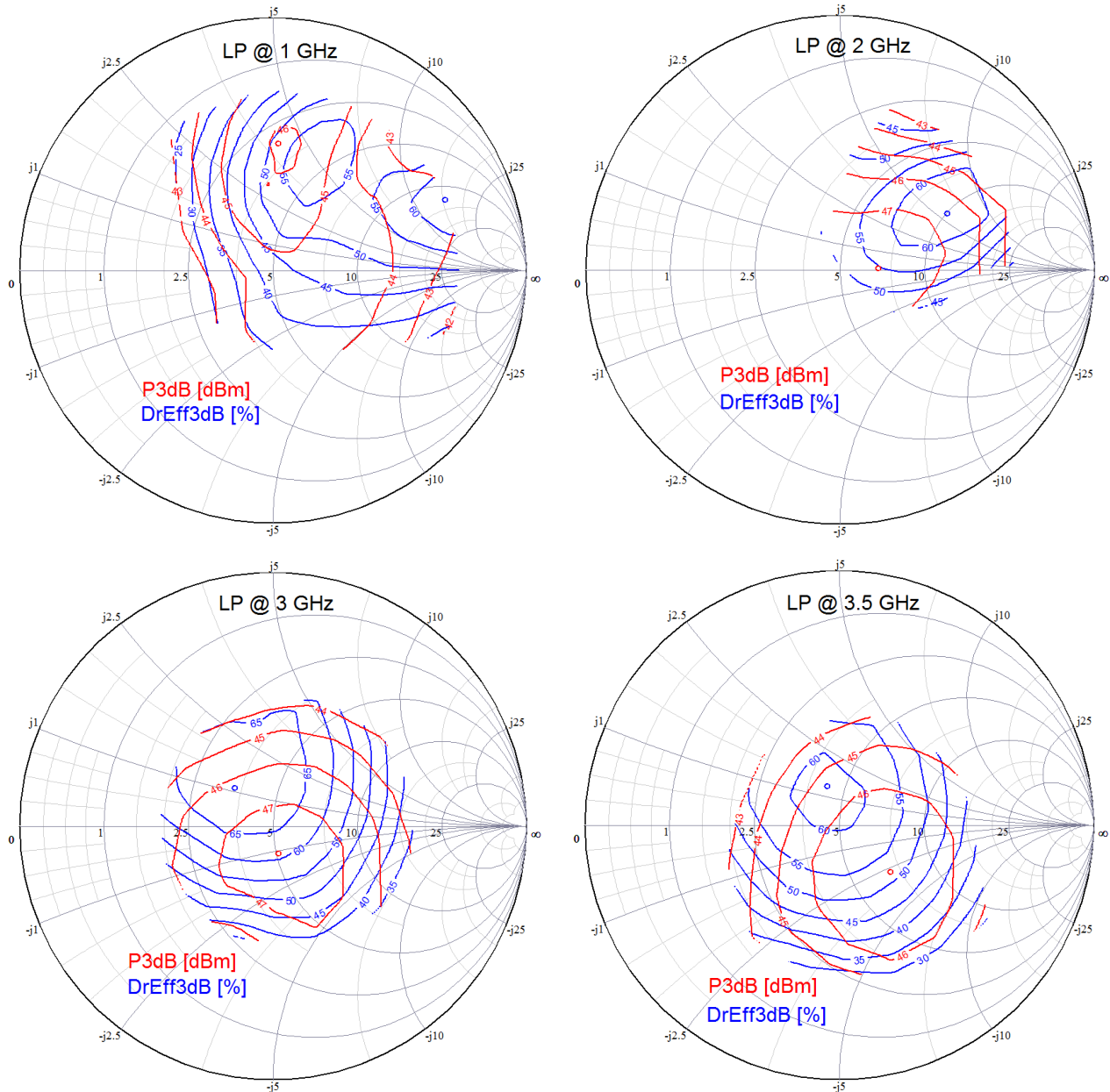
## Maximum Channel Temperature

$T_{BASE} = 85^\circ\text{C}$ ,  $P_D = 50\text{ W}$



## Load Pull Smith Charts (1, 2)

RF performance that the device typically exhibits when placed in the specified impedance environment. The impedances are not the impedances of the device, they are the impedances presented to the device via an RF circuit or load-pull system. The impedances listed follow an optimized trajectory to maintain high power and high efficiency.

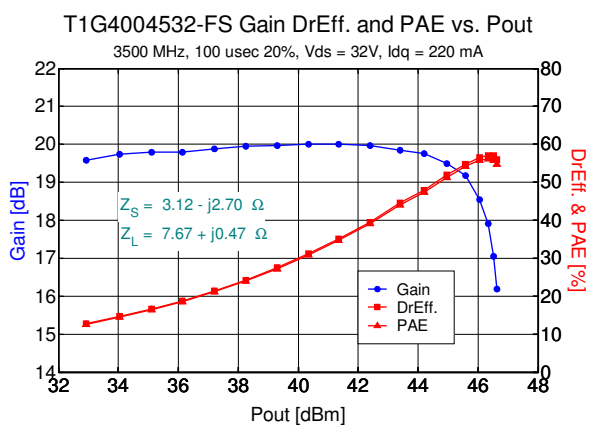
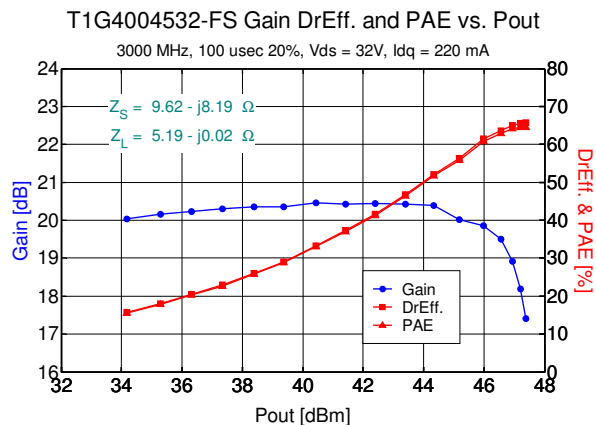
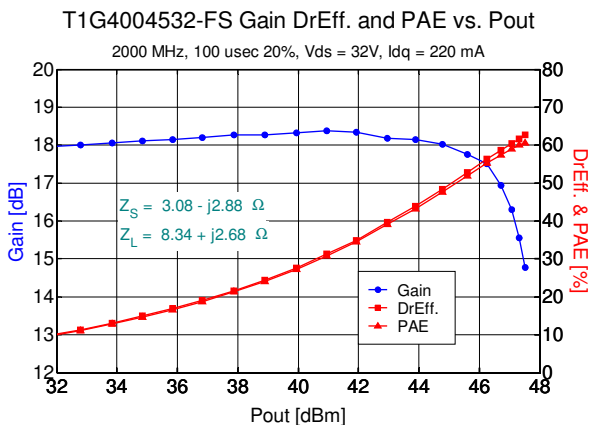
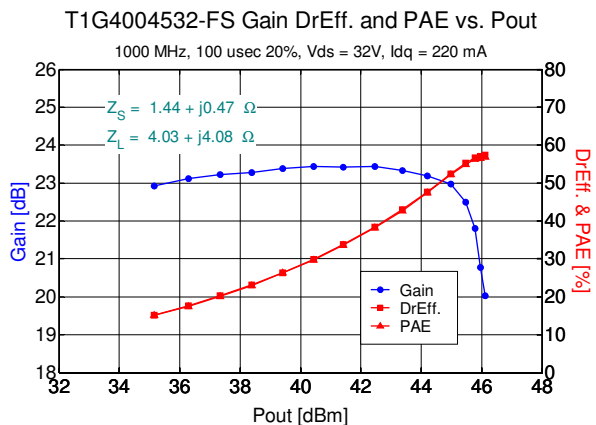


### Notes:

1. Test Conditions:  $V_{DS} = 32 \text{ V}$ ,  $I_{DQ} = 220 \text{ mA}$
2. Test Signal: Pulse Width = 100  $\mu\text{sec}$ , Duty Cycle = 20%
3. Reference plane is at the device package leads

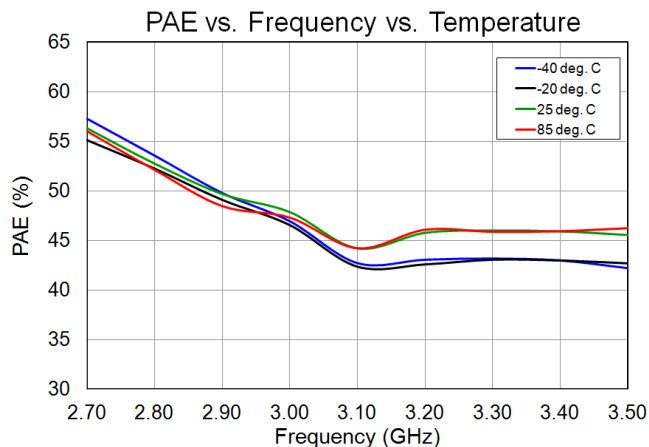
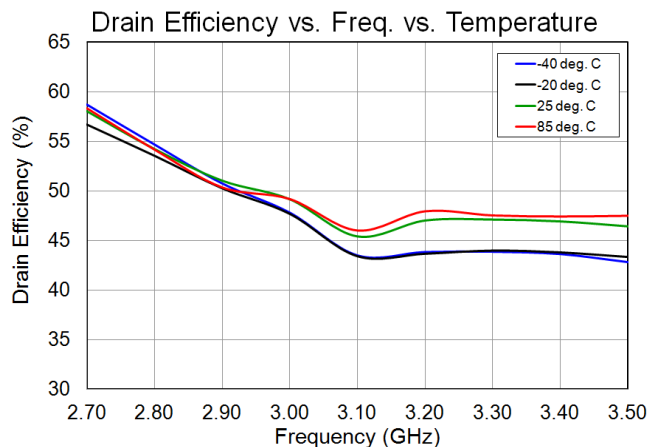
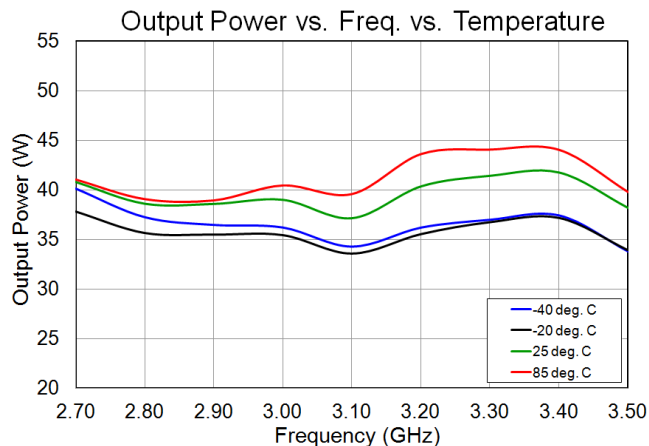
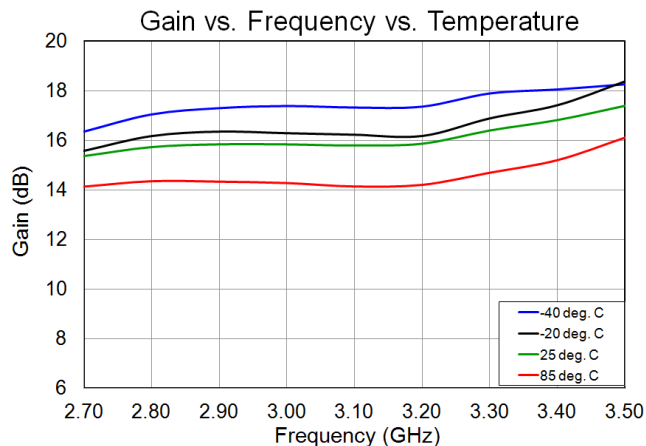
**Typical Performance**

Performance is based on compromised impedance point and measured at DUT reference plane.



## Performance Over Temperature (1, 2)

Performance measured in TriQuint's 2.7 GHz to 3.5 GHz Evaluation Board at 3 dB compression.

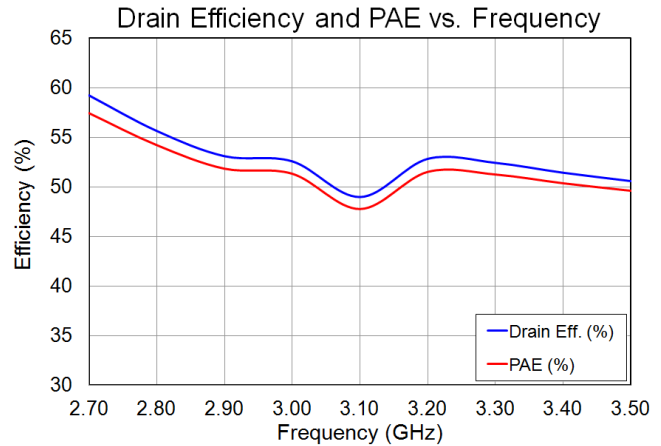
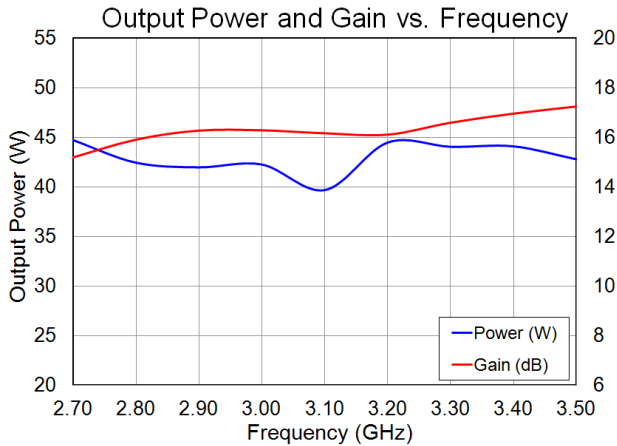


**Notes:**

1. Test Conditions:  $V_{DS} = 32\text{ V}$ ,  $I_{DQ} = 220\text{ mA}$
2. Test Signal: Pulse Width = 100  $\mu\text{s}$ , Duty Cycle = 20%

## Evaluation Board Performance (1, 2)

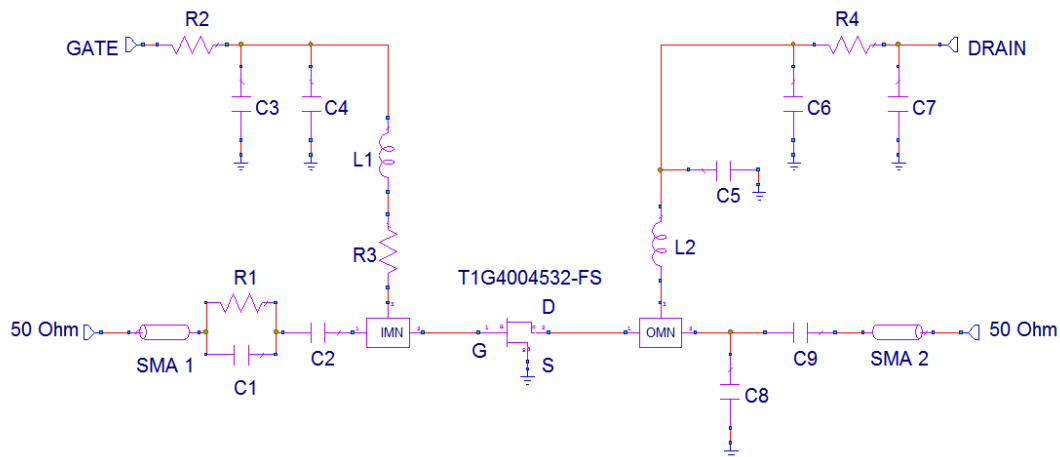
Performance at 3 dB Compression



Notes:

1. Test Conditions:  $V_{DS} = 32\text{ V}$ ,  $I_{DQ} = 220\text{ mA}$
2. Test Signal: Pulse Width =  $100\text{ }\mu\text{s}$ , Duty Cycle = 20 %

## Application Circuit



### Bias-up Procedure

- Set gate voltage ( $V_G$ ) to  $-5.0\text{ V}$
- Set drain voltage ( $V_D$ ) to  $32\text{ V}$
- Slowly increase  $V_G$  until quiescent  $I_D$  is  $220\text{ mA}$ .
- Apply RF signal

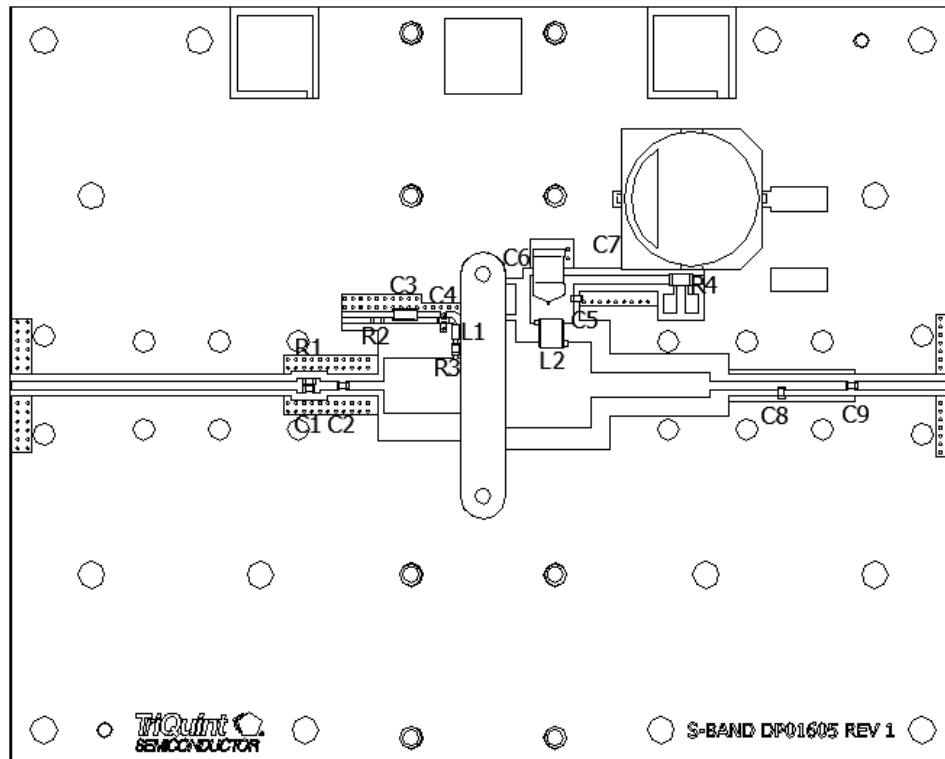
### Bias-down Procedure

- Turn off RF signal
- Turn off  $V_D$  and wait 1 second to allow drain capacitor dissipation
- Turn off  $V_G$



## Evaluation Board Layout

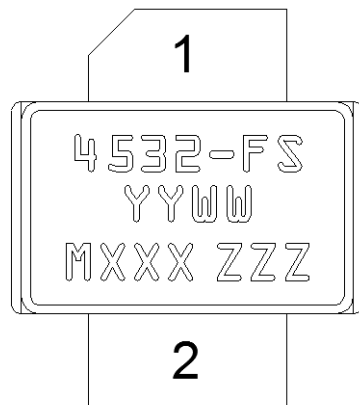
Top RF layer is 0.020" thick Rogers RO4350B,  $\epsilon_r = 3.48$ . The pad pattern shown has been developed and tested for optimized assembly at TriQuint Semiconductor. The PCB land pattern has been developed to accommodate lead and package tolerances.



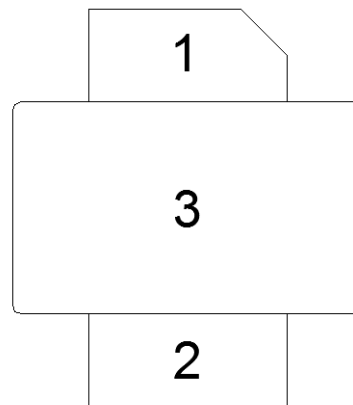
## Bill of Materials

Reference Des.	Value	Qty	Manufacturer	Part Number
C1, C2, C9	5.6 pF	3	ATC	600S5R6AW250T
C3	10 uF	1	TDK	C1632X5R0J106M
C4	1.0 uF	1	Murata	NFM18PS105R0J3
C5	100 pF	1	ATC	600S100AW250T
C6	10 uF	1	Vishay Sprague	595D106X9035D2T
C7	220 uF	1	AFK	AFK227M2AR44B
C8	0.7 pF	1	ATC	600S0R7AW250T
L1	3.6 nH	1	Coilcraft	0603HC-3N6XJL
L2	6.6 nH	1	Coilcraft	GA3093-ALB
R1	100 Ohms	1	Vishay Dale	CRCW0603100RFKEC
R2, R3	10 Ohms	2	Vishay Dale	CRCW060310R0FKEA
R4	0.01 Ohms	1	Panasonic	ERJ-8BWJR010V

## Pin Layout



TOP VIEW



BOTTOM VIEW

Note:

The T1G4004532-FS will be marked with the “4532” designator and a lot code marked below the part designator. The “YY” represents the last two digits of the calendar year the part was manufactured, the “WW” is the work week of the assembly lot start, the “MXXX” is the production lot number, and the “ZZZ” is an auto-generated serial number.

## Pin Description

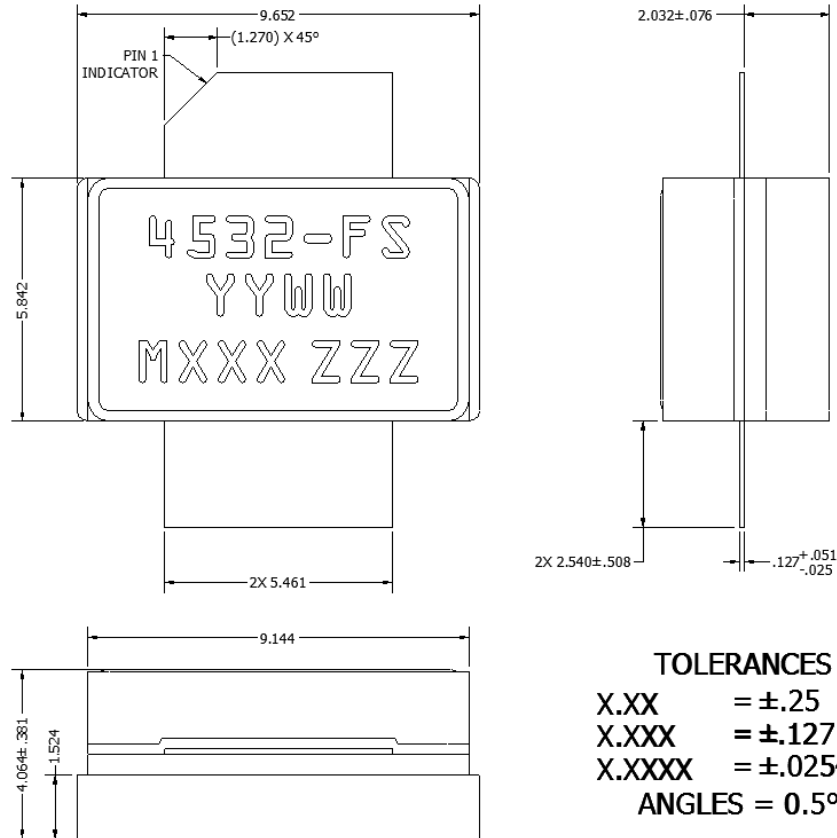
Pin	Symbol	Description
1	$V_D$ / RF OUT	Drain voltage / RF Output matched to 50 ohms; see EVB Layout on page 9 as an example.
2	$V_G$ / RF IN	Gate voltage / RF Input matched to 50 ohms; see EVB Layout on page 9 as an example.
3	Flange	Source connected to ground; see EVB Layout on page 9 as an example.

Notes:

Thermal resistance measured to bottom of package

**Mechanical Information**

All dimensions are in millimeters.



**Note:**

This package is lead-free/RoHS-compliant. The plating material on the leads is NiAu. It is compatible with both lead-free and tin-lead soldering processes.

## Product Compliance Information

### ESD Sensitivity Ratings



Caution! ESD-Sensitive Device

ESD Rating: Class 1B  
 Value: Passes  $\geq 500$  V to  $< 1000$  V max.  
 Test: Human Body Model (HBM)  
 Standard: JEDEC Standard JESD22-A114

### MSL Rating

The part is rated Moisture Sensitivity Level 3 at 260°C per JEDEC standard IPC/JEDEC J-STD-020.

### ECCN

US Department of Commerce EAR99

### Solderability

Compatible with the latest version of J-STD-020, Lead free solder, 260°C

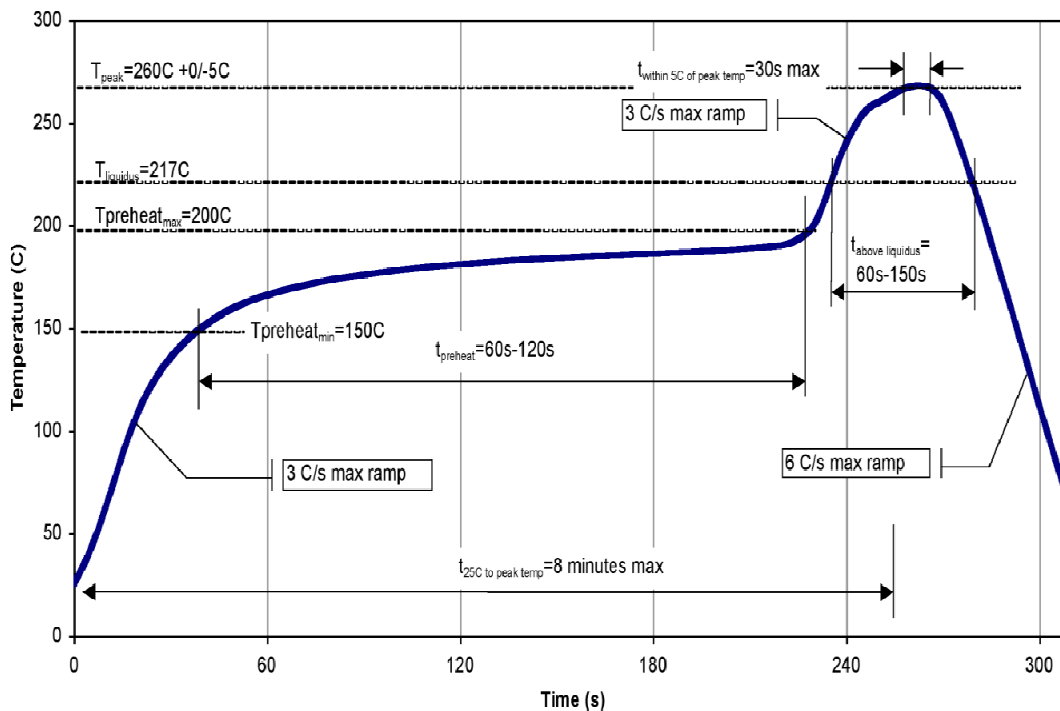
### RoHS Compliance

This part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C<sub>15</sub>H<sub>12</sub>Br<sub>4</sub>O<sub>2</sub>) Free
- PFOS Free
- SVHC Free

## Recommended Soldering Temperature Profile



## Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations, and information about TriQuint:

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